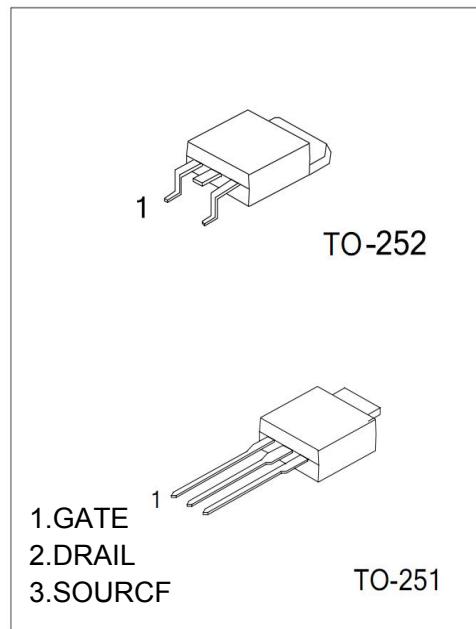




SHENZHEN MENGKE ELECTRONICS TECHNOLOGY CO.,LTD

TO-252/251 Plastic-Encapsulate MOSFETS**MK10N10****N-Channel 100-V(D-S) Power MOSFET**

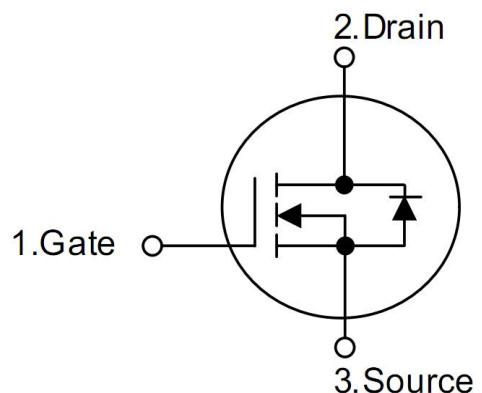
V(BR)DSS	RDS(on)MAX	ID
100 V	143mΩ@ 10 V	10A
	156mΩ@ 4.5 V	

Equivalent Circuit:**General Description:**

The high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition , this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes . The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power suppliers, converters and PWM motor controls , these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

MARKING: MK 10N10 MKD / U ****
(D-252) / (U-251)**FEATURE:**

- ※ Power switching application
- ※ Hard switched and high frequency circuits
- ※ Uninterruptible power supply
- ※ Fully characterized avalanche voltage and current
- ※ Excellent package for good heat dissipation
- ※ Good stability and uniformity with high EAS

SYMBOL:**Maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	VGS	±25	
Continuous Drain Current	ID	10	A
Pulsed Diode Current	IDM	30	
Power Dissipation	PD	45	W
Thermal Resistance from Junction to Ambient (t≤10s)	R _{θJA}	100	°C/W
Operating Junction	T _J	150	°C
Storage Temperature	T _{STG}	-55~+150	



MOSFET ELECTRICAL CHARACTERISTICS

Static Electrical Characteristics ($T_a = 25^\circ\text{C}$ Unless Otherwise Noted)

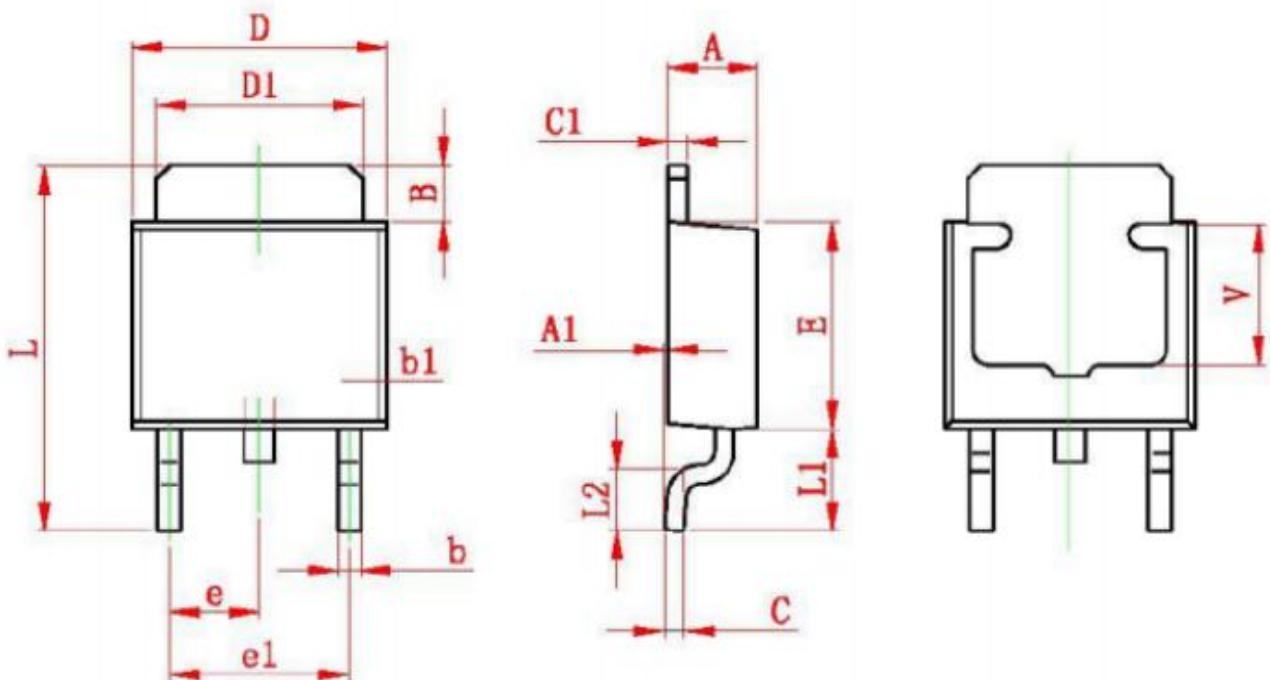
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-source breakdown voltage	V(BR)DSS	VGS = 0V, ID = 250µA	100			V
Gate-source threshold voltage	VGS(th)	VDS = VGS, ID = 250µA	1		3	V
Gate-source leakage	IGSS	VDS = 0V, VGS = ±25V			±100	nA
Zero gate voltage drain current	IDSS	VDS = 100V, VGS = 0V			1	µA
Drain-source on-state resistancea	RDS(on)	VGS = 10V, ID = 6.5A			143	mΩ
	RDS(on)	VGS = 4.5V, ID = 5A			156	mΩ
Forward transconductancea	gfs	VDS = 25V, ID = 5A		15		S
Diode forward voltage	VSD	IS= 5A, VGS=0V		0.8	1.3	V
Dynamic						
Input capacitance	Ciss	VDS = 25V, VGS = 0V, f=1MHz		860		pF
Output capacitance	Coss			56		pF
Reverse transfer capacitanceb	Crss			44		pF
Total gate charge	Qg	VDS = 80V, VGS = 10V, ID = 10A		26		nC
Gate-source charge	Qgs			7		nC
Gate-drain charge	Qgd			5.4		nC
Switchingb						
Turn-on delay time	td(on)	VDD= 50V RL= 25Ω, ID = 10A, VGEN= 10V, Rg= 25Ω		4.8		ns
Rise time	tr			4.5		ns
Turn-off delay time	td(off)			67		ns
Fall time	tf			34		ns
Drain-Source Diode Characteristics						
Continuous Source-Drain Diode Current	IS				10	A
Pulsed Diode forward Current	ISM				30	A
Body Diode Reverse Recovery Time	Trr	IF= 10A, dI/dt=100A/µs		50		ns
Body Diode Reverse Recovery Charge	Qrr	IF= 10A, dI/dt=100A/µs		80		nC

Note :

1. Repetitive Rating : Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, $t < 10$ sec.
3. Pulse Test : Pulse Width≤300µs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production testing.



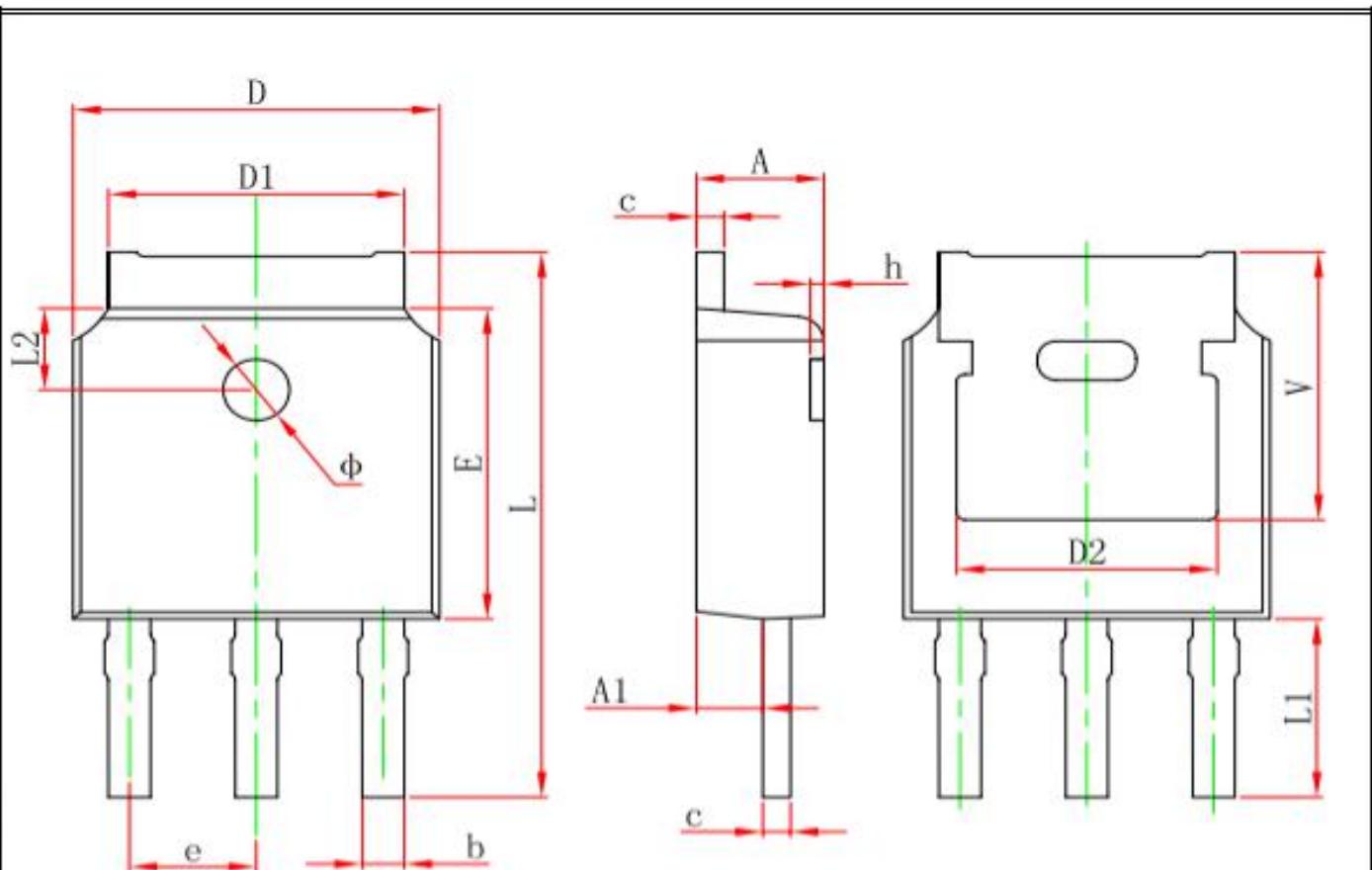
PACKAGE OUTLINE DIMENSIONS :



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP		0.091 TYP	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
V	3.80 REF		0.150 REF	



PACKAGE OUTLINE DIMENSIONS :



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.860	1.160	0.034	0.046
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	10.400	11.000	0.409	0.433
L1	3.300	3.700	0.130	0.146
L2	1.600 REF.		0.063 REF.	
Φ	1.100	1.300	0.043	0.051
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	